

Description

The SI7615CDN-T1-GE3 uses advanced trench

technology to provide excellent $R_{DS(ON)}$, low gate

charge and operation with gate voltages as low

as 4.5V. This device is suitable for use as a

Battery protection or in other Switching application.

General Features

V_{DS} = -20V I_D =-60A

 $R_{DS(ON)} < 10 \text{ m}\Omega @ V_{GS} = -4.5V$

Application

Battery protection

Load switch

Uninterruptible power supply

Package Marking and Ordering Information

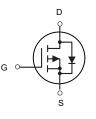
Product ID	Pack	Brand	Qty(PCS)
SI7615CDN-T1-GE3	DFN3X3-8L (PowerPAK1212-8)	HXY MOSFET	5000

Absolute Maximum Ratings (Tc=25°C unless otherwise noted)

Symbol	Parameter	Rating	Units
VDS	Drain-Source Voltage	-20	V
VGS	Gate-Source Voltage	±12	V
I₀@Tc=25°C	Continuous Drain Current, V _{GS} @ 10V ¹	-60	А
I _D @T _C =100°C	Continuous Drain Current, V _{GS} @ 10V ¹	-30	А
IDM	Pulsed Drain Current ²	-78	А
P₀@Tc=25°C	Total Power Dissipation ⁴	22	W
TSTG	Storage Temperature Range	-55 to 150	°C
TJ	Operating Junction Temperature Range	-55 to 150	°C
R₀JA	Thermal Resistance Junction-ambient ¹	75	°C/W
R₀JC	Thermal Resistance Junction-Case ¹	4.2	°C/W



DFN3X3-8L (PowerPAK1212-8)



P-Channel MOSFET



Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =-250uA	-20			V
$\triangle \text{BV}_\text{DSS} / \triangle \text{T}_\text{J}$	BV _{DSS} Temperature Coefficient	Reference to 25° C , I _D =-1mA		-0.012		V/°C
		V _{GS} =-4.5V , I _D =-10A		7	10	
Rds(on)	Static Drain-Source On-Resistance ²	V _{GS} =-2.5V , I _D =-8A		9	12	mΩ
V _{GS(th)}	Gate Threshold Voltage		-0.4	-0.7	-1.0	V
$ riangle V_{GS(th)}$	V _{GS(th)} Temperature Coefficient	VGS-VDS, ID2300A		2.94		mV/°C
IDSS	Drain-Source Leakage Current	V _{DS} =-15V , V _{GS} =0V , T _J =25°C			1	uA
I _{GSS}	Gate-Source Leakage Current	$V_{GS}=\pm 12 V$, $V_{DS}=0V$			±100	nA
gfs	Forward Transconductance	V _{DS} =-5V , I _D =-10A		43		S
Qg	Total Gate Charge (-4.5V)			35		
Q _{gs}	Gate-Source Charge	$V_{\text{DS}}\text{=-10V}$, $V_{\text{GS}}\text{=-4.5V}$, $I_{\text{D}}\text{=-10A}$		5.0		nC
Q_{gd}	Gate-Drain Charge			10		
T _{d(on)}	Turn-On Delay Time			12.0		
Tr	Rise Time	V_{DD} =-10V , V_{GS} =-4.5V ,		40.0		ns
T _{d(off)}	Turn-Off Delay Time	R _G =3.3Ω, I _D =-10A		30		115
T _f	Fall Time	<u> </u>		10		
Ciss	Input Capacitance			2800		
Coss	Output Capacitance	V_{DS} =-15V , V_{GS} =0V , f=1MHz		690		pF
Crss	Reverse Transfer Capacitance			590		
ls	Continuous Source Current ^{1,4}	−−−V _G =V _D =0V , Force Current			-60.0	А
lsм	Pulsed Source Current ^{2,4}				-	А
Vsd	Diode Forward Voltage ²	V _{GS} =0V , I _S =-1A , T _J =25°C			-1.2	V
t _{rr}	Reverse Recovery Time	IF=-10A , dl/dt=100A/μs ,		27		nS
Qrr	Reverse Recovery Charge	T _J =25°C		17.8		nC

Electrical Characteristics (T_J=25 °C, unless otherwise noted)

Note :

1. The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.

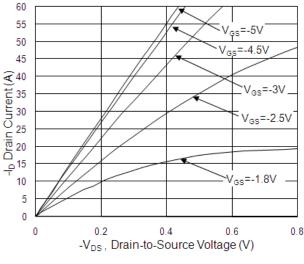
2.The data tested by pulsed , pulse width $\,\leq\,$ 300us , duty cycle $\,\leq\,$ 2%

3. The power dissipation is limited by 150°C junction temperature

4. The data is theoretically the same as I_{D} and I_{DM} , in real applications , should be limited by total power dissipation.



Typical Characteristics





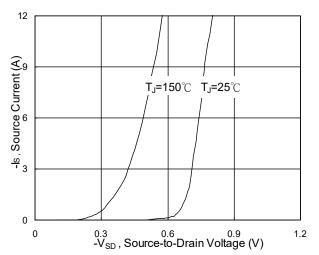


Fig.3 Forward Characteristics of Reverse

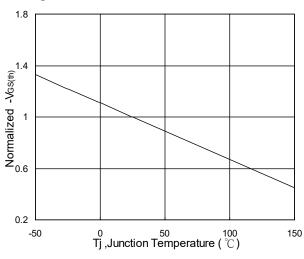


Fig.5 Normalized V_{GS(th)} vs. T_J

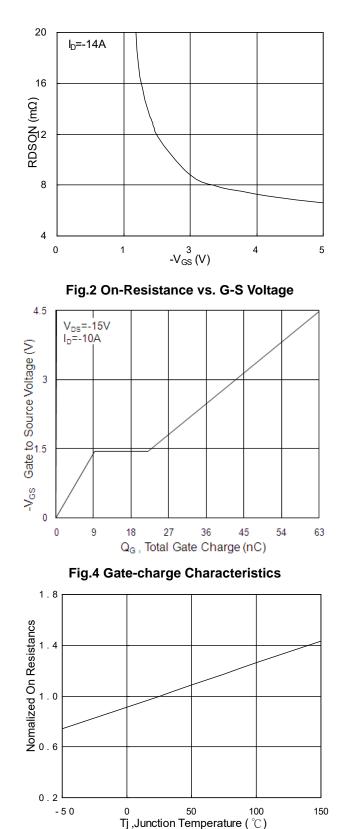
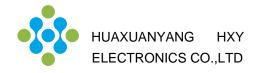
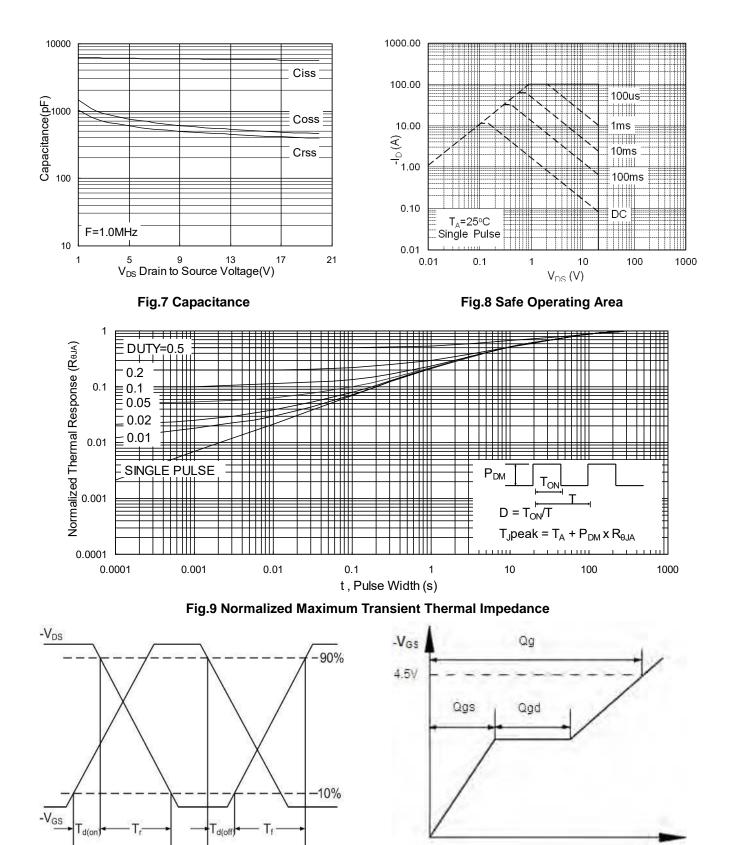


Fig.6 Normalized RDSON vs. TJ





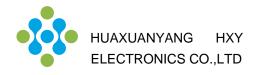
Charge

Fig.10 Switching Time Waveform

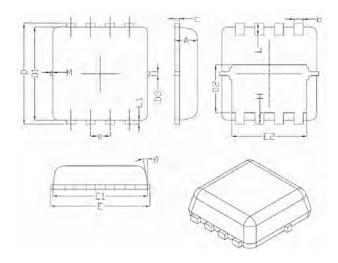
Toff

Fig.11 Gate Charge Waveform

Ton



DFN3X3-8L(PowerPAK1212-8) Package Information



Sumhal	Dimensions In Millimeters			
Symbol	Min.	Nom.	Max.	
A	0.70	0.75	0.80	
b	0.25	0.30	0.35	
с	0.10	0.15	0.25	
D	3.25	3.35	3.45	
D1	3.00	3.10	3.20	
D2	1.48	1.58	1.68	
D3	-	0.13	-	
E	3.20	3.30	3.40	
E1	3.00	3.15	3.20	
E2	2.39	2.49	2.59	
е	0.65BSC			
Н	0.30	0.39	0.50	
L	0.30	0.40	0.50	
L1	-	0.13	-	
М	*	*	0.15	
θ		10 [°]	12 [°]	



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